



Product Change Notification

Change Notification #: 117357 - 00
Change Title: Intel® Bridge Board AHWBPBGB24R,
PCN 117357-00, Product Design,
Bridge Board Firmware Update in Factory
Date of Publication: December 17, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	January 6, 2020
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel is implementing the following changes on Intel® Bridge Board listed in the "Products Affected" table below:

- Update Bridge Board Firmware in Factory to revision 50.5.2-1326.

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
AHWBPBGB24R	948929	J48522-001	H88231-250	J48522-002	H88231-251

PCN Revision History:

Date of Revision: December 17, 2019	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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